SINGLE-SIDED STORAGE MEDIA

Inventor: Joseph Allen, San Carlos, CA (US)

Correspondence Address:
SEAGATE TECHNOLOGY LLC
C/O Murabito Hao & Barnes LLP
Two North Market Street, Third Floor
San Jose, CA 95113 (US)

Assignee: SEAGATE TECHNOLOGY LLC, Scotts Valley, CA (US)

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ABSTRACT

In one embodiment, a method can include providing first and second intermediate structures, each having first and second surfaces. Also, the method can include placing the first surface of the first intermediate structure adjacent to the first surface of the second intermediate structure, such that the first and second intermediate structures are in a stacked relationship. Additionally, the method can include simultaneously removing at least a portion of each of the second surfaces of the first and second intermediate structures while in the stacked relationship. Furthermore, the method can include forming a plating layer on each of the first and second surfaces of each of the first and second intermediate structures. Moreover, the method can include forming a magnetic layer on the second surface but not the first surface of each of the first and second intermediate structures.
Fig. 1
(Prior Art)
Surface Machined Blank 112

Two-Sided Grinding 128

Rough Ground Blank 132

Washing 136

Drying 140

One-Sided Grinding 600

Finish Ground Blank 604

Further Processing 650

Fig. 6
Fig. 7

Sized Blank

One-Sided Rough Grinding

Rough Ground Blank

Washing

Drying

One-Sided Fine Grinding

Finish Ground Blank

Further Processing
Substrate Blank

ID/OD Sizing

One Sided Surface Machining

Surface Machined Blank

Washing

Drying

Annealing

One-Sided Rough Grinding

Washing and Drying

One-Sided Fine Grinding

Further Processing

Fig. 8
SINGLE-SIDED STORAGE MEDIA

CROSS REFERENCE TO RELATED APPLICATIONS


FIELD OF THE INVENTION

[0002] The present invention is related generally to recording media and specifically to single-sided magnetic recording media. This invention refers to single-sided magnetic recording media of all sizes and formats. The invention text refers to the thickness of 95 mm±5 mil recording media but encompasses other sizes, including but not limited to, 95 mm±69 mil thick, 84 mm±50 mil thick, 48 mm±25 mil thick, 95 mm±31.5 mil thick, etc.

BACKGROUND OF THE INVENTION

[0003] Hard disk drives are an efficient and cost effective solution for data storage. Depending upon the requirements of the particular application, a disk drive may include anywhere from one to twelve hard disks and data may be stored on one or both surfaces of each disk. While hard disk drives are traditionally thought of as a component of a personal computer or as a network server, usage has expanded to include other storage applications such as set top boxes for recording and time shifting of television programs, personal digital assistants, cameras, music players and other consumer electronic devices, each having differing information-storage capacity requirements.

[0004] As aerial bit densities of hard disks have dramatically increased in recent years, the large data storage capacities of dual-sided magnetic storage media far exceed demand in many applications. For example, dual-sided hard disks in personal computers have much greater storage capacity than most consumers require during the useful life of the computer. Consumers thus are forced to pay substantial amounts for excess data storage capacity. The intense price competition in the magnetic storage media industry has forced many disk drive manufacturers to offer single-sided magnetic storage media as an alternative.

[0005] Single-sided storage media are of two types. In one type, a double-sided disk configured to store information on both sides of the disk is installed with a single read/write head serving only one side of the disk. In the other type, known as a single-sided processed disk, only one side of the disk is provided with an information-storage magnetic layer. The other side of the disk does not have or is free of an information-storage layer. Single-sided processed disks not only have sufficient storage capacities to satisfy most consumers, but also can be manufactured at lower costs than dual-sided disks due to reduced material usage.

[0006] One prior art process used for manufacturing single-sided processed disks is shown in FIG. 1. Referring to FIG. 1, a disc-shaped substrate blank 100, which is typically aluminum, is stamped out of a sheet of material. The substrate blank 100, in step 104, is annealed to a zero temper and the inner and outer diameters of the substrate blank cut to size using a single point lathe, such as a diamond lathe. For example, one common size is an outer diameter of about 95 mm and an inner diameter of about 25 mm. Chamfers are typically formed on the upper and lower substrate blank surfaces in this step. In step 108, the sized disk is surface machined using a diamond tool. This step removes excess material from both sides of the sized disk and provides a surface machined blank 112 having the desired approximate disk thickness. The surface machined blank 112 is then annealed to remove, at least partially, the effects of cold work from steps 104 and 112. In step 128, both sides of the disk are ground to produce a finished ground blank 132. The finished ground blank 132 is washed, dried, and inspected in steps 136, 140, and 144, respectively. The finished ground blank 132 is then plated in step 148 to provide a plated substrate blank 152. The plating step is performed by known techniques, such as by electroless plating techniques, and provides a layer of nickel phosphorus on each side of the plated substrate blank 152.

[0007] The plated substrate blank 152 is subjected to further processing 156. In one prior art process, the nickel phosphorus layer on a selected side of the plated substrate blank 152 is rough and fine polished. A disk holder contains compartments (or holes) for receiving two disks simultaneously (referred to as “two-at-a-time disk polishing”). Upper and lower polishing pads polish the outwardly facing surfaces of the adjacent stacked disks. The back-to-back contacting disk surfaces are not polished.

[0008] In following process steps, the plated disks are merged for processing, subjected to data zone texturing, washed to remove any debris or contaminants from the data zone texturing step, layer zone textured by known techniques followed by washing of the upper disk surfaces, subjected to sputtered deposition of an underlayer, magnetic layer, and overcoat layer, subjected to the application of a lubrication layer, and subjected to tape burning. “Merging” refers to placing the disks back-to-back such that the upper disk surfaces face outwardly. In other words, the lower disk surfaces are adjacent to one another. The disks can be contact merged in which case the lower disk surfaces of each disk physically contact one another or gap merged in which case the lower disk surfaces of each disk are separated by a gap. Finally, the adjacent disks are separated or demerged to provide the finished disk. With reference to FIG. 2, the lower side 204 of the disk 200 does not store information, while the upper side 208 of the disk 200 does.

SUMMARY OF THE INVENTION

These and other needs are addressed by the various embodiments and configurations of the present invention. The present invention is related generally to surface processing of magnetic storage media, particularly before the surfaces are plated.

In a first embodiment, a method for manufacturing a single-sided storage media that includes providing a first and second substrate, placing the first surface of the first intermediate structure adjacent to the second surface of the second medium structure, such that the first and second intermediate structures are in a stacked relationship; simultaneously removing a portion of each of the second surfaces of the first and second intermediate structures while in the stacked relationship; forming a plating layer on each of the first and second layers of each of the first and second intermediate structures; and therefor forming a magnetic layer on the second surface but not the first surface of each of the first and second intermediate structures. In step (c), a portion of the first surfaces is typically not removed. As a result, the first surface has first degree of roughness that is greater than the second degree of roughness.

In another embodiment, a magnetic storage medium is provided that includes:

- (a) a substrate having first and second surfaces;
- (b) first and second plating layers on the first and second surfaces, respectively; and
- (c) a magnetic layer located adjacent to the second surface. The second surface has a roughness of no more than about 300% of the roughness of the first surface.

The manufacturing and magnetic disk described above can provide substantial cost benefits and price reductions. The use of single-side surface processing can double the grinding capacity for each processing unit, lower energy usage required to process each substrate, lower substrate processing time, and lower substrate costs. Unlike the prior art, the present invention can obviate the need to machine and grind both sides of the substrate to extremely tight tolerances and surface finishes.

These and other advantages will be apparent from the disclosure of the invention(s) contained herein.

The above-described embodiments and configurations are neither complete nor exhaustive. As will be appreciated, other embodiments of the invention are possible utilizing, alone or in combination, one or more of the features set forth above or described in detail below.

As used herein, “at least one,” “one or more,” and “and/or” are open-ended expressions that are both conjunctive and disjunctive in operation. For example, each of the expressions “at least one of A, B and C,” “at least one of A, B, or C,” “one or more of A, B, and C,” “one or more of A, B, or C” and “A, B, and/or C” means A alone, B alone, C alone, A and B together, A and C together, B and C together, or A, B and C together.

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 is a prior art flowchart of a single-sided magnetic disk manufacturing process;
FIG. 2 is a cross-sectional view of a prior art finished ground blank taken along a vertical center plane of the blank;
FIG. 3 is a cross-sectional view of a pair of disk blanks in a holder according to an embodiment of the present invention;
FIG. 4 is a cross-sectional view of a disk blank according to an embodiment of the present invention taken along a vertical center plane of the disk blank;
FIG. 5 is a plated substrate blank manufacturing process according to an embodiment of the present invention;
FIG. 6 is a plated substrate blank manufacturing process according to an embodiment of the present invention;
FIG. 7 is a plated substrate blank manufacturing process according to an embodiment of the present invention;
FIG. 8 is a plated substrate blank manufacturing process according to an embodiment of the present invention;
FIG. 9 is a cross-sectional view of a magnetic disk according to an embodiment of the present invention taken along a vertical center plane of the disk blank.

DETAILED DESCRIPTION

With reference to FIG. 4, which depicts a finished ground blank 400 according to the present invention, the upper disk surface 404 (or the active side) is considerably smoother (or has a lower degree of roughness) than the lower disk surface 408 (or the inactive side). Surprisingly, it has
been discovered that both the active and inactive sides may be plated effectively, notwithstanding a substantial difference in surface roughness between the two sides. There is thus no reason to surface process both sides to provide nearly or precisely identical degrees of surface roughness.

[0037] Different manufacturing processes may be used to produce the blank of FIG. 4.

[0038] The manufacturing process of the first embodiment is shown in FIG. 5.

[0039] In step 500, the surface machined blank 112 is ground by a suitable grinding device, such as a planetary grinding machine, using two-at-a-time techniques. In other words, the blank 112 is merged with another blank 112 using either contact or gap merging techniques so that the exteriorly facing active sides of the blanks are subjected to grinding while the interiorly facing inactive sides are not. The merged assembly is shown in FIG. 3A.

[0040] Referring to FIG. 3A, first and second blanks 112a, b are contact merged in a holder 300. As can be seen from the FIGS. 3A and 3B, the active sides 324 of the blanks face outwardly and project slightly above the upper and lower surfaces 304 and 308 of the holder 300. As the holder 300 moves into the grinding step 500, this offset 380 permits the upper and lower plate grinding pad assemblies 384 and 386 to contact the outwardly facing blank surfaces without hindrance from the holder 300. The offset 380 typically ranges from about 0.05 to about 0.25 mm. The inactive sides 320 are in physical contact with one another, though a gap may be positioned between the opposing sides.

[0041] The grinding of step 500 is rough grinding. As used herein, “rough grinding” refers to grinding of no more than about 30μ grit and more typically ranging from about 15μ to about 20μ grit. The grinding step 500 typically reduces the thickness of the surface machined blank 112 by from about 3.0 to about 4.0%. As will be appreciated, the initial thickness of the (as punched) substrate blank 100 ranges from 51 to about 53 mils; the thickness of the surface machined blank 112 from about 49 to about 50 mils; and the thickness of the finished substrate from about 49 to about 51 mils. The grinding step 500 is typically performed for a time ranging from about 300 to about 600 seconds.

[0042] Following grinding, the ground blanks 504 are removed from the holder 300 and placed in a process cassette to maintain the ground or active side of the disk in a desired orientation. The surface machined and unground (inactive) side thus becomes the back side of the ground blank. The surface machined and ground (active) side thus becomes the front side of the ground blank.

[0043] In this embodiment, the degree of roughness of the active side 404 is no more than about 30% and even more typically ranges from about 20 to about 30% of the degree of roughness of the inactive side. Quantitatively, the roughness of the active side typically is no more than about 60 Å, more typically no more than about 45 Å, and even more typically ranges from about 40 Å to about 60 Å. The roughness of the inactive side typically is at least about 100 Å, more typically at least about 90 Å, and even more typically ranges from about 90 Å to about 110 Å.

[0044] The manufacturing process of the second embodiment is shown in FIG. 6.

[0045] The process differs from the process of FIG. 5, in that a conventional (one-disk-at-a-time) rough grinding step 128 is employed but the fine grinding is performed by one-sided grinding techniques in step 600. As used herein, “fine grinding” refers to grinding of at least about 5μ grit and more typically ranging from about 4μ to about 6μ grit. The grinding step 600 is performed using the holder 300 with two rough ground blanks 132 being placed back-to-back in the holder 300. The grinding step 600 typically reduces the thickness of the rough ground blank 132 by an amount ranging from about 1 to about 3%. The grinding step 600 is typically performed for a time ranging from about 100 to about 300 seconds.

[0046] The active side of the finish ground blank 604 is surface machined, rough ground, and fine ground while the inactive side of the blank 604 is only surface machined and rough ground. The blank 604 is subjected to further processing (which includes not only the further processing steps 156 of FIG. 1, but also the plating step 148).

[0047] In this embodiment, the degree of roughness of the active side is no more than about 10% and even more typically ranges from about 5 to about 15% of the degree of roughness of the inactive side 408. Quantitatively, the roughness of the active side typically is no more than about 60 Å, more typically no more than about 45 Å, and even more typically ranges from about 40 Å to about 60 Å while the roughness of the inactive side typically is at least about 100 Å, more typically at least about 90 Å, and even more typically ranges from about 90 Å to about 110 Å.

[0048] The manufacturing process of the third embodiment is shown in FIG. 7.

[0049] The process differs from the process of FIGS. 5 and 6, in that rough grinding and diamond turning of both sides of the blank are eliminated. The as-punched and sized blank 701 is rough and finished ground on only one (the active) side using two-at-a-time techniques. When completed, the unground and unturned side or inactive side becomes the lower side of the disk.

[0050] Referring now to FIG. 7, the sized blank 701 is merged along with another sized blank 701 in the holder 300 with the inactive sides of the blanks being adjacent to one another and facing inwardly and the active sides of the blanks facing outwardly in opposite directions from one another. The holder 300 is progressively moved through the rough grinding step 704, washing step 136, drying step 140, and fine grinding step 708.

[0051] The active side of the finish ground blank 712 is rough and fine ground while the inactive side of the blank 604 is only sized and is not rough ground. Neither side has been surface machined 108.

[0052] In this embodiment, the degree of roughness of the active side is no more than about 60% and even more typically ranges from about 50 to about 70% of the degree of roughness of the inactive side 408. Quantitatively, the roughness of the active side typically is no more than about 60 Å, more typically no more than about 45 Å, and even more typically ranges from about 40 Å to about 60 Å while the roughness of the inactive side typically is at least about 250 Å, more typically at least about 200 Å, and even more typically ranges from about 150 Å to about 250 Å.

[0053] The manufacturing process of the fourth embodiment is shown in FIG. 8.

[0054] The process differs from the above processes in that only one (the active) side of the sized blank is surface machined and rough and/or fine ground. The inactive side is free of surface machining and rough and fine grinding. When completed, the unmachined and unground side, or inactive side, becomes the lower side of the disk.
Referring now to FIG. 8, the sized blank 701 is sized 104, and only one side of the sized blank is surface machined, such as by diamond turning. The surface machined blank 804 is washed 116, dried 120, and annealed 124. The blank is then optionally rough ground 704 by two-at-a-time techniques, optionally washed and dried 808, and optionally fine ground by two-at-a-time techniques. The holder 300 is typically used only in steps 800, 804, 116, 120, 124, 704, 808, and 708.

The active side of the finish ground blank is surface machined and/or rough and/or fine ground while the inactive side of the blank 604 is unfinished. Normally, the inactive is only sized and surface cleaned and is neither machine nor ground.

In this embodiment, the smooth active side is readily discernible from the rough inactive side. Preferably, the degree of roughness of the active side is no more than about 60% and even more typically ranges from about 50 to about 70% of the degree of roughness of the inactive side 408. Quantitatively, the roughness of the active side typically is no more than about 60 A, more typically no more than about 45 A, and even more typically ranges from about 40 A to about 60 A while the roughness of the inactive side typically is at least about 250 A, more typically at least about 200 A, and even more typically ranges from about 150 A to about 250 A.

In all of the processes, the blanks are not merged during plating so that a nickel phosphorus layer is applied both to the active and inactive sides of the blank. After plating, the blanks are merged as described above with reference to FIG. 1 and subjected to further processing 156 to provide the finished one-sided magnetic storage media.

An embodiment of a magnetic disk produced by a process including one of the above embodiments is shown in FIG. 9. The disk 900 (which is not drawn to scale) includes the substrate (or finished ground blank) 904, upper and lower plating layers 908a,b, an underlayer 912, an information-containing structure 916 typically including one or more magnetic and non-magnetic layers, an overcoat layer 920, and a lubricant layer 924. As will be appreciated, the substrate 904 can be any suitable material, such as aluminum, aluminum alloys (e.g., AlMg), glass, ceramic materials, titanium, titanium alloys and/or graphite. A particularly preferred material is a 5000 series aluminum alloy designated as 5D86 (which is an alloy of aluminum and magnesium). The plating layers 908a,b can be any suitable material for achieving acceptable magnetic recording properties in the overlying magnetic layer(s), such as iron oxide, nickel phosphorus, nickel molybdenum phosphorus, and nickel antimony phosphorus, with the latter three materials being preferred. The underlayer 912 can be any material capable of providing the desired crystallography in the information-containing structure 916. Preferably, the underlayer 912 is chromium or a chromium alloy. The structure 916 typically includes one or more magnetic layers that can be any ferromagnetic alloy, with the cobalt-platinum-based quaternary alloy having the formula CoPbXY or the five element alloy CoPbXYZ, wherein X and Y are tantalum, chromium, boron, nickel, or copper. Nonmagnetic layer(s), such as chrome or ruthenium, can be positioned between multiple magnetic layers. The overcoat layer 920 can be any suitable overcoat material, with carbon being preferred, and the lubricant layer 924 can be any suitable material (such as a perfluoropolyether). As noted previously, the roughness of the surface 926 on the inactive side 930 is greater than the roughness of the surface 932 on the active side 934 of the disk 900.

A number of variations and modifications of the invention can be used. It would be possible to provide for some features of the invention without providing others.

For example in one alternative embodiment, the planetary grinder used in the grinding steps is replaced with a single high speed unit that uses a grind wheel or a continuous abrasive web resulting in a finished ground blank.

The present invention, in various embodiments, includes components, methods, processes, systems and/or apparatus substantially as depicted and described herein, including various embodiments, subcombinations, and subsets thereof. Those of skill in the art will understand how to make and use the present invention after understanding the present disclosure. The present invention, in various embodiments, includes providing devices and processes in the presence of items not depicted and/or described herein or in various embodiments hereof, including in the absence of such items as may have been used in previous devices or processes, e.g., for improving performance, achieving ease and/or reducing cost of implementation.

The foregoing discussion of the invention has been presented for purposes of illustration and description. The foregoing is not intended to limit the invention to the form or forms disclosed herein. In the foregoing Detailed Description, for example, various features of the invention are grouped together in one or more embodiments for the purpose of streamlining the disclosure. This method of disclosure is not to be interpreted as reflecting an intention that the claimed invention requires more features than are expressly recited in each claim. Rather, as the following claims reflect, inventive aspects lie in less than all features of a single foregoing disclosed embodiment. Thus, the following claims are hereby incorporated into this Detailed Description, with each claim standing on its own as a separate preferred embodiment of the invention.

Moreover, though the description of the invention has included description of one or more embodiments and certain variations and modifications, other variations and modifications are within the scope of the invention, e.g., as may be within the skill and knowledge of those in the art, after understanding the present disclosure. It is intended to obtain rights which include alternative embodiments to the extent permitted, including alternate, interchangeable and/or equivalent structures, functions, ranges or steps to those claimed, whether or not such alternate, interchangeable and/or equivalent structures, functions, ranges or steps are disclosed herein, and without intending to publicly dedicate any patentable subject matter.

What is claimed is:

1. A magnetic storage medium, comprising:
   a substrate having first and second surfaces;
   first and second plating layers on the first and second surfaces, respectively; and
   a magnetic layer located adjacent to the second surface, wherein the second surface has a roughness of no more than about 70% of the roughness of the first surface.

2. The magnetic storage medium of claim 1, wherein the second surface has a roughness ranging from about 50% to about 70% of the roughness of the first surface.

3. The magnetic storage medium of claim 1, wherein the first roughness is at least about 2 A and the second roughness is no more than about 200 A.
4. The magnetic storage medium of claim 1, wherein the first roughness ranges from about 1 Å to about 2 Å and the second roughness ranges from about 150 Å to about 250 Å.

5. The magnetic storage medium of claim 1, wherein the first roughness is at least about 250 Å and the second roughness is no more than about 60 Å.

6. The magnetic storage medium of claim 1, wherein the first roughness is at least about 250 Å and the second roughness is no more than about 45 Å.

7. The magnetic storage medium of claim 1, wherein the first roughness is at least about 200 Å and the second roughness is no more than about 60 Å.

8. The magnetic storage medium of claim 1, wherein the first roughness is at least about 200 Å and the second roughness is no more than about 45 Å.

9. The magnetic storage medium of claim 1, wherein the first roughness ranges from about 150 Å to about 250 Å and the second roughness ranges from about 40 Å to about 60 Å.

10. The magnetic storage medium of claim 1, wherein the first roughness is at least about 100 Å and the second roughness is no more than about 60 Å.

11. A method comprising:
(a) providing an intermediate structure, the intermediate structure comprising a substrate disk having first and second sides, wherein the second surface has a second roughness that is at least about 10% of a first roughness of the first surface;
(b) forming a plating layer on each of the first and second surfaces; and
(c) forming an information storage layer adjacent to the second side but not the first side to provide an information-storage media.

12. The method of claim 11, wherein (a) comprises:
(a1) simultaneously removing at least a portion of each of the second sides of the first and second intermediate structures while in the stacked relationship, wherein, in each of the first and second intermediate structures, the first side has first degree of roughness that is greater than a second degree of roughness of the second side.

13. The method of claim 12 wherein, in (a1), the first and second intermediate structures are one of contact and gap merged in a holder.

14. The method of claim 13, wherein each of the outwardly facing second sides of each of the first and second intermediate structures are offset outwardly from an adjacent surface of the holder, whereby an abrasive surface contacts the corresponding second side without contacting the adjacent holder surface.

15. The method of claim 12, wherein (a) comprises:
(a2) surface machining the first and second sides of the first and second intermediate structures; and wherein, in the simultaneously removing, each of the second sides are contacted with an abrasive surface having a grit size of no more than about 5μ.

16. The method of claim 15, wherein the first degree of roughness is at least about 60 Å and the second degree of roughness is no more than about 40 Å.

17. The method of claim 15, wherein the second degree of roughness is no more than about 60% of the first degree of roughness.

18. The method of claim 12, wherein (a) comprises:
(a2) surface machining the first and second sides of the first and second intermediate structures; and wherein, in the simultaneously removing, each of the second sides are contacted with an abrasive surface having a grit size of at least about 5μ.

19. The method of claim 18, wherein the first degree of roughness is at least about 60 Å, and the second degree of roughness is no more than about 40 Å.

20. The method of claim 18, wherein the second degree of roughness is no more than about 60% of the first degree of roughness.

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